



SHEET 1 OF 1

Form PTO 1449  
(Modified)U.S. DEPARTMENT OF COMMERCE  
PATENT AND TRADEMARK OFFICE

ATTY DOCKET NO.

246918US2

SERIAL NO.

10/759,029

## LIST OF REFERENCES CITED BY APPLICANT

APPLICANT

Hideki SUGIURA, et al.

FILING DATE

January 20, 2004

GROUP

1756

## U.S. PATENT DOCUMENTS

EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE
JND	AA	6,308,027	10/23/2001	M. OBU, et al.	399	110	
JND	AB	6,628,913	09/30/2003	J. MATSUMOTO, et al.	399	258	
JND	AC	6,628,908	09/30/2003	J. MATSUMOTO, et al.	399	106	
JND	AD	6,674,982	01/06/2004	M. SAITOH, et al.	399	110	
JND	AE	6,630,276	10/07/2003	H. SUGIURA, et al.	430	108.3	
JND	AF	6,542,707	04/01/2003	S. MURAMATSU, et al.	399	258	
JND	AG	6,597,883	07/22/2003	S. MURAMATSU, et al.	399	258	
JND	AH	6,667,141	12/23/2003	Y. IWAMOTO, et al.	430	111.4	
JND	AI	6,697,584	02/24/2004	K. TSUNODA, et al.	399	91	
	AJ						
	AK						
	AL						
	AM						
	AN						

## FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	DATE	COUNTRY	TRANSLATION	
					YES	NO
JND	AO	9-179331	07/11/1997	JAPAN (with English Abstract)		X
JND	AP	10-142835	05/29/1998	JAPAN (with English Abstract)		X
JND	AQ	11-327197	11/26/1999	JAPAN (with English Abstract)		X
JND	AR	2001-51444	02/23/2001	JAPAN (with English Abstract)		X
	AS					
	AT					
	AU					
	AV					

## OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, etc.)

	AW	
	AX	
	AY	
	AZ	

☐ Additional References sheet(s) attached

Examiner

DO TE, JAMES L

Date Considered

11/7/05

\*Examiner: Initial if reference is considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.



# LIST OF RELATED CASES

<u>Docket Number</u>	<u>Serial or Patent Number</u>	<u>Filing or Issue Date</u>	<u>Inventor/ Applicant</u>
<del>193383US2</del>	<del>6,308,027</del>	<del>10/23/01</del>	<del>OBU et al.</del>
<del>213234US3</del>	<del>6,628,913</del>	<del>09/30/03</del>	<del>MATSUMOTO et al.</del>
<del>214272US3</del>	<del>6,628,908</del>	<del>09/30/03</del>	<del>MATSUMOTO et al.</del>
<del>214437US3</del>	<del>6,674,982</del>	<del>01/06/04</del>	<del>SAITOH et al.</del>
<i>JP</i> 214495US2	09/964,584	09/28/01	SHINKAI et al.
<i>originally filed claim, abstract, and drawings</i>			
<del>215816US0</del>	<del>6,630,276</del>	<del>10/07/03</del>	<del>SUGIURA et al.</del>
<del>215944US3</del>	<del>6,542,707</del>	<del>04/01/03</del>	<del>MURAMATSU et al.</del>
<i>JP</i> 217549US2	10/020,925	12/19/01	MOCHIZUKI et al.
"	"	"	"
<i>JP</i> 218952US0	10/059,240	01/31/02	SUGIURA et al.
"	"	"	"
<del>218979US3</del>	<del>6,597,883</del>	<del>07/22/03</del>	<del>MURAMATSU et al.</del>
<i>JP</i> 219007US0	10/059,239	01/31/02	MOCHIZUKI et al.
"	"	"	"
<i>JP</i> 219568US0	10/086,415	03/04/02	SUGIURA et al.
"	"	"	"
<i>JP</i> 219850US0	10/077,813	02/20/02	HIGUCHI et al.
"	"	"	"
<del>219857US0</del>	<del>6,667,141</del>	<del>12/23/03</del>	<del>IWAMOTO et al.</del>
<i>JP</i> 221039US2	10/101,994	03/21/02	UEDA
"	"	"	"
<i>JP</i> 221089US0	10/101,756	03/21/02	SASAKI et al.
"	"	"	"
<i>JP</i> 221246US0	10/107,157	03/28/02	MASUDA et al.
"	"	"	"
<i>JP</i> 222880US0	10/151,103	05/21/02	KONDO
"	"	"	"
<i>JP</i> 223523US0	10/153,627	05/24/02	SUZUKI et al.
<i>originally filed claims and abstract</i>			
<i>JP</i> 224723US0	10/176,578	06/24/02	YAGI et al.
<i>originally filed claims, abstract, and drawings</i>			
<del>225304US2</del>	<del>6,697,584</del>	<del>02/24/04</del>	<del>TSUNODA et al.</del>

\*Present Application; listed for information

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filed 4/16/04

JM	226638US0	10/212,736	08/07/02	SUGIURA et al.
	<i>originally filed claims, abstract, and drawings</i>			
JM	227097US2	10/231,281	08/30/02	KOSUGE
	"	"	"	"
JM	230633US3	10/293,334	11/14/02	SAITO et al.
	"	"	"	"
JM	231768US0	10/318,109	12/13/02	SUGIURA et al.
	"	"	"	"
JM	232409US0	10/329,538	12/27/02	HIGUCHI et al.
	"	"	"	"
JM	234792US3	10/383,750	03/10/03	NAKAI et al.
	"	"	"	"
JM	235225US0	10/385,719	03/12/03	SUGIURA et al.
	"	"	"	"
JM	235551US0	10/391,575	03/20/03	SUZUKI et al.
	<i>originally filed claims and abstract</i>			
JM	236475US3	10/417,169	04/17/03	FUKUCHI
	<i>originally filed claims, abstract, and drawings</i>			
JM	237957US3	10/441,105	05/20/03	KASAHARA et al.
	"	"	"	"
JM	238644US3	10/454,689	06/05/03	MATSUMOTO et al.
	"	"	"	"
JM	239544US2	10/607,014	06/27/03	TOMITA et al.
	"	"	"	"
JM	239700US2	10/609,399	07/01/03	KATOH et al.
	<i>originally filed claims and abstract</i>			
	<del>246918US2*</del>	<del>10/759,029</del>	<del>01/20/04</del>	<del>SUGIURA et al.</del>

NOTE, JAWIS L 11/7/05

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EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE
JD	AA	5,912,100	06/15/1999	M. AOKI, et al.			
JD	AB	6,004,715	12/21/1999	M. SUZUKI, et al.			
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	AI						
	AJ						
	AK						
	AL						
	AM						
	AN						

## FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	DATE	COUNTRY	TRANSLATION	
					YES	NO
JD	AO	1 283 236	02/12/2003	EUROPE		X
	AP					
	AQ					
	AR					
	AS					
	AT					
	AU					
	AV					

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JD	AW	Derwent Publications, AN 1994-276351, XP-002274877, JP 06-208247, July 26, 1994				
JD	AX	Derwent Publications, AN 1992-014364, XP-002274878, JP 03-265863, November 26, 1991				
JD	AY	Derwent Publications, AN 1990-265838, XP-002274927, JP 02-187768, July 23, 1990				
	AZ					

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Examiner

DOTE, JAVIS

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